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	PRODUCT NO	PRODUCT NO	POS	DIM X	DIM Y		IPTION	
	63453-X04	63453-X04LF(8)	2X2	2	4.8		µm Au	
	X 0 6	XO6LF 🛦	2X3	4	6.8	1 0.10	µm Au	
	X08	X08LF	2 X 4	6	8.8		SIGNED	
	X I 0	XIOLF	2X5	8	10.8	LEAD FREE 3 0.38	µm Au A	
Ξ	X I 2	XI2LF	2 X 6	10	12.8	BASE P/N		
5	X   4	XI4LF	2X7	12	14.8			
Ξ	X   6	XI6LF	2 X 8	4	16.8	NOTES:		
	ΧΙ8	XI8LF	2 X 9	16	18.8	I.MATERIAL :		
▋╚┓-	X20	X20LF	2 X I 0	18	20.8	BODY : GLASS FILLED PCT UL 94V-O BLACK	<u> </u>	
l s	X22	X22LF	2 X I I	20	22.8	TERMINAL : PHOSPHOR BRONZE		
1 X	X 2 4	X24LF	2XI2	22	24.8	<ol> <li>CUT SURFACE IS UNPLATED</li> </ol>		
	X26	X26LF	2XI3	24	26.8	3 TERMINAL RETENTION FORCE 0.5 Kg MIN		
Б	X28	X28LF	2 X I 4	26	28.8	4. TOLERANCE UNLESS OTHERWISE NOTED $\pm$ 0.25		
Ľ	X 30	X 30LF	2XI5	28	30.8	5. FOR 63453-XI6TR ONLY (TAPE AND REEL PACKAGING)	B	
	X 3 2	X 32LF	2XI6	30	32.8	A PICK-UP CAP IS PROVIDED IN THE CENTRE OF THE PRODUCT		
	X 3 4	X 3 4 L F	2X17	32	34.8	(SEE FIG.I) FOR PICK AND PLACE APPLICATION.		
	X 36	X 36L F	2X18	34	36.8	PICK-UP CAP TIGHTNESS IS 7LB MAX.		
	X 38	X 38LF	2 X I 9	36	38.8	6. THE HOUSING WILL WITHSTAND EXPOSURE TO 255°C PEAK		
	X 40	X 4 0 L F	2X20	38	40.8	TEMPERATURE FOR IO SECONDS IN A CONVECTION, INFRA-RED		
	X 4 2	X 42LF	2X21	40	42.8	OR VAPOR PHASE REFLOW OVEN.		
<b>S</b>	X 4 4 X 4 6	X44LF	2X22	42	44.8	7. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK		
	X 4 6 X 4 8	X46LF X48LF V	2X23 2X24	44	46.0	TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER		
С	X 40	X 50LF (8)	2X24	40	50.8	APPLICATION WITH A 1.57MM MINIMUM THICK CIRCUT BOARD.	С	
p o	×30		LNLJ	40	50.0	8 THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER		
FCI.	COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.							
orma sclo	9. A 👍 SYMBOL WILL BE NEXT TO ANY DIMENSION, VIEW OR NOTE WHICH HAS BEEN MODIFIED WITH THE CURRENT DRAWING REVISION.							
conF e in or di Copyr	PICK	-UP CAP				WHICH HAS DEEN MODIFIED WITH THE CORRENT DRAWING REVISION.		
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docu RIETA 1 on -	<u>FIG_I</u>						F	
This PROPF shown other	BTV F = 2004-04-1						et 2 of 2	
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